# 320842

# CH \$40.00

#### PATENT ASSIGNMENT

### Electronic Version v1.1 Stylesheet Version v1.1

| SUBMISSION TYPE:      | NEW ASSIGNMENT |
|-----------------------|----------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT     |

#### **CONVEYING PARTY DATA**

| Name         | Execution Date |
|--------------|----------------|
| Woo Suk KWON | 07/21/2010     |
| Suk Woo LEE  | 08/19/2010     |
| Ji Ae SEOK   | 08/19/2010     |

#### **RECEIVING PARTY DATA**

| Name:           | LG ELECTRONICS INC.             |  |
|-----------------|---------------------------------|--|
| Street Address: | 20 Yeouido-dong Yeongdeungpo-gu |  |
| City:           | Seoul                           |  |
| State/Country:  | REPUBLIC OF KOREA               |  |
| Postal Code:    | 150-721                         |  |

#### PROPERTY NUMBERS Total: 1

| Property Type       | Number   |
|---------------------|----------|
| Application Number: | 12920842 |

#### **CORRESPONDENCE DATA**

Fax Number: (703)205-8050

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 7032058000 Email: ply@bskb.com

Correspondent Name: Birch, Stewart, Kolasch, & Birch, LLP

Address Line 1: P.O. Box 747

Address Line 4: Falls Church, VIRGINIA 22040-0747

| ATTORNEY DOCKET NUMBER: | 5438-0193PUS1   |
|-------------------------|-----------------|
| NAME OF SUBMITTER:      | Esther H. Chong |

Total Attachments: 4

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PATENT REEL: 024939 FRAME: 0752 source=20100903assignment#page3.tif source=20100903assignment#page4.tif

PATENT REEL: 024939 FRAME: 0753

## BIRCH, STEWART, KOLASCH & BIRCH, LLP

UNITED STATES PATENT RIGHTS, OR UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS.

#### ASSIGNMENT

| Application No.   | 12/920,842  | Filed 5             | September 3, 2010                                       |       |
|---|---|---------------------|---|-------|
| Insert Name(s) of Inventor(s)   | ***(Given Name  | FAMILY NAME (ALL CA | \P\$))***   |       |
| •••   | WHEREAS, KWON, Woo Suk<br>undersigned) has (have) invented or               |                     | OK, Ji Ae (hereinafter designated as the provements in: | e.    |
| Insert Title<br>of Invention  | METHOD FOR TRANSMITTING   | DATA USING HARQ     |   |       |
|   | for which an application for Letter<br>undersigned (except in the case of a |                     | States of America has been executed b                   | y the |
| Insert Date   | on  | July 21, 2010       |   | and   |
| of Signing of<br>Application<br>Insert Name<br>of Assignee                                    | WHEREAS, LG ELECTRONICS   | VINC.               |   |       |
| Insert Address of 20 Yeouido-dong Yeongdeungpo-gu Seoul 150-721 Republic of Korea of Assignee |   |                     | ublic of Korea  |       |

its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patenti(s) that may be granted therefor in the United States of America and in any foreign countries.

CHECK BOX

IF APPROPRIATE

NOW, THEREFORE, in consideration of the sum of Ten Dollars (\$10.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries:

and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree (s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation; division, conversion or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

| Date _ | 2010.9. | 21 | Name of Inventor Kwon Woo Suk             |   |
|--------|---------|----|---|---|
|        |         |    | (signature) KWON, Woo Suk                 |   |
| Date   |         |    | Name of Inventor (signature) LEE, Suk Woo |   |
| Date_  |         |    | Name of Inventor (signature) SEOK, Ji Ae  | *************************************** |

# BIRCH, STEWART, KOLASCH & BIRCH, LLP

UNITED STATES PATENT RIGHTS, OR UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

#### **ASSIGNMENT**

| Application No.   | 12/920,842   | Filed Septem  | ber 3, 2010  |  |
|---|--|---|--|--|
| Insert Name(s) of Inventor(s)   | ***(Given Name FAMILY NAME (ALL CAPS))***  |   |  |  |
| or inventor(s)  | WHEREAS, KWON, Woo Suk; LEE, Suk Woundersigned) has (have) invented certain new and  |   |  | he   |
| Insert Title  | METHOD FOR TRANSMITTING DATA USING   | HARQ  |  |  |
| of Invention  | for which an application for Letters Patent of the undersigned (except in the case of a provisional application)   |   | f America has been executed  | by the                                     |
| Insert Date   | on August 19,  | .010  |  | and  |
| of Signing of<br>Application<br>Insert Name<br>of Assignee<br>Insert Address<br>of Assignee | WHEREAS, LG ELECTRONICS INC. of 20 Yeouido-dong Yeongdeungpo-gu Seoul 150  | 721 Republic of   | Котеа  |  |
| CHECK BOX IF APPROPRIATE  | its heirs, successors, legal representatives and desirous of acquiring the entire right, title and interpatent(s) that may be granted therefor in the Unite  in any foreign countries.   | est in and to sai   | d invention and in and to any  | nee) is<br>Letters                         |
|   | NOW, THEREFORE, in consideration of the sur<br>paid, the receipt of which is hereby acknowled,<br>undersigned has (have) sold, assigned and trans-<br>transfer unto said Assignee the full and exclusiv<br>America, its territories, dependencies and possessi<br>and all Letters Patent(s) which may be granted the<br>dependencies and possessions, and if the box above | ed, and other geterred, and by the right to the said ons and the entire erefor in the Uni | ood and valuable consideration<br>these presents does sell, assigned invention in the United State right, title and interest in and ited States of America, its terr | on, the gn and tates of l to any ritories, |

and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

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The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s)

Page 1 of 2

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

| Date _ | ,             | Name of Inventor (signature) KWON, Woo Suk |
|--------|---------------|--|
| Date _ | Aug. 19.2010, | Name of Inventor Lee Sut Woo               |
|        | •             | (signature) LEE, Suk Woo                   |
| Date   | Aug. 19.2010, | Name of Inventor JT Ac SEOK                |
|        |               | (signature) SEOK, Ji Ae                    |

RECORDED: 09/03/2010